

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Chi-Hyun PARK</td><td>09/03/2007</td></tr><tr><td>Young-Hoon KWON</td><td>09/03/2007</td></tr><tr><td>Sang-Boh YUN</td><td>09/03/2007</td></tr></tbody></table>	Name	Execution Date	Chi-Hyun PARK	09/03/2007	Young-Hoon KWON	09/03/2007	Sang-Boh YUN	09/03/2007	
Name	Execution Date								
Chi-Hyun PARK	09/03/2007								
Young-Hoon KWON	09/03/2007								
Sang-Boh YUN	09/03/2007								
RECEIVING PARTY DATA									
Name:	Samsung Electronics Co., Ltd.								
Street Address:	416, Maetan-dong, Yeongtong-gu,								
City:	Suwon-si, Gyeonggi-do								
State/Country:	KOREA, REPUBLIC OF								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11851448</td></tr></tbody></table>	Property Type	Number	Application Number:	11851448					
Property Type	Number								
Application Number:	11851448								
CORRESPONDENCE DATA									
Fax Number:	(202)403-3587								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	202-293-2941								
Email:	mshin@myiplaw.net								
Correspondent Name:	Maeng-Ho Shin								
Address Line 1:	1730 M Street, NW								
Address Line 2:	Suite 807								
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20036								
ATTORNEY DOCKET NUMBER:	0202-0028								
NAME OF SUBMITTER:	/Maeng-Ho Shin/								
Total Attachments: 3 source=0202-0028AssignmentAsFiled#page1.tif source=0202-0028AssignmentAsFiled#page2.tif									

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PATENT
REEL: 019796 FRAME: 0343

RECORDATION FORM COVER SHEET
PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

1) Chi-Hyun PARK, 2) Young-Hoon KWON, and 3) Sang-Boh YUN

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) September 3, 2007

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other _____

2. Name and address of receiving party(ies)

Name: Samsung Electronics Co., Ltd.

Internal Address: _____

Street Address: 416, Maetan-dong, Yeongtong-gu

City: Suwon-city

State: Gyeonggi-do

Country: Republic of Korea

Zip: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

A. Patent Application No.(s)

11/851,448

☐ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Maeng-Ho Shin

Internal Address: _____

Street Address: 1730 M Street, NW, Suite 807

City: Washington

State: District of Columbia

Zip: 20036

Phone Number: 202-293-0804

Fax Number: 202-403-3587

Email Address: usdocketing@myiplaw.net

6. Total number of applications and patents involved: One

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

☒ Authorized to be charged by credit card

☐ Authorized to be charged to deposit account

☐ Enclosed

☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____

Expiration Date _____

b. Deposit Account Number _____

Authorized User Name _____

9. Signature:

/Maeng-Ho SHIN/ Reg. #53,859

Signature

September 07, 2007

Date

Maeng-Ho Shin

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

Assignment

WHEREAS, the following inventors, namely 1) Chi-Hyun PARK, 2) Young-Hoon KWON, and 3) Sang-Boh YUN, all citizens of the Republic of Korea and residing respectfully at 1) #515, Charmang officetel, Ingyo-dong 1119, Paldal-gu, Suwon-si, Gyeonggi-do, Republic of Korea, 2) #502-1301, Chungsol maeul Joogong 5danji APT, Guemgok-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea, and 3) #701-501, Leemaecheon Seongji APT, Leemae-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea (hereinafter called "Assignors"), having made or discovered certain new, useful and non-obvious improvements in an invention having a working title of:

METHOD AND APPARATUS FOR REMOVING INTERFERENCE FROM UPLINK SIGNAL IN TIME DIVISION DUPLEX (TDD) SYSTEM,

for which a United States Patent Application is being filed concurrently herewith or, if not being concurrently filed, was filed on 09/07/2007 and assigned Serial No. 11/851,448; and,

WHEREAS, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter called "Assignee"), is desirous of acquiring the entire right, title and interest therein;

NOW, THEREFORE, BE IT KNOWN that for and in good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignors do hereby sell, assign and transfer unto said Assignee the entire and exclusive worldwide right, title and interest in and to all said inventions and discoveries disclosed in said application, and in and to said application, any and all substitutions, divisions, provisionals, conversions of provisionals and continuations thereof, and in and to all Letters Patent, United States and foreign, that may be granted for said inventions and discoveries, and in and to all extensions, renewals and reissues thereof; and the right to file any foreign application and/or claim priority under the provisions of any international treaty or convention arising from this application or any divisional, continuing, substitute or reissue application therefrom. The aforesaid assignment includes the right in and to all income, royalties, damages and payments, now or hereafter due or payable with respect to any Letters Patent which may be granted, and in and to all causes of action (either in law or in equity), and the right to sue, counterclaim, and recover for past, present and future infringement of the rights assigned or to be assigned under this Assignment, as fully and entirely as the same would have been held and enjoyed by Assignors if this sale, assignment and transfer had not been made.

Assignors covenant and agree, without further compensation to said Assignors but at Assignee's expense:

- a. to execute:
 - i. all papers to be used in connection with this application and any divisional, continuing, substitute or reissue application thereof, as the Assignee may deem necessary or expedient, and
 - ii. all papers in connection with any interference, litigation, mediation, arbitration or other proceeding relating to this application or any divisional, continuing, substitute or reissue application thereof, as may be necessary or expedient;
- b. to cooperate with the Assignee in every way possible in obtaining evidence and going forward in any interference, litigation, mediation, arbitration or other proceeding relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof;

- c. to communicate to the Assignee any facts relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof, including evidence for any interference, litigation, mediation, arbitration or other proceeding relating to said invention, whenever requested;
- d. to testify in any interference, litigation, mediation, arbitration or other proceeding relating to said invention, said application and any divisional, continuing, substitute or reissue application thereof whenever requested; and
- e. to perform all other affirmative acts which may be necessary or desirable to secure full and complete protection of the inventions and discoveries or that may be necessary or desirable to vest in Assignee the complete title to the inventions and discoveries and Letters Patent hereby conveyed and to enable Assignee to record title.

Assignors hereby authorize and request the United States Patent and Trademark Office or any other issuing authority to issue any and all Letters Patent that may be granted upon this invention and/or this application or any divisional, continuing, substitute or reissue application thereof to the Assignee, its legal representatives, successors and assigns.

Assignors each hereby represent, covenant and warrant that he or she has the full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

The provisions of this Assignment are binding upon each Assignor's heirs, legal representatives and/or administrators and assigns.

Assignors hereby grant to the law firm of Stimson, Shin & Associates LLP of Washington, DC and its attorneys and agents as associated with Customer No. 68103 the authority and power to insert on this instrument any further identification which may be necessary or desirable for purposes of recordation in the United States Patent and Trademark Office or a Patent Office of any foreign country.

Signature of First Inventor:


Chi-Hyun PARK


September 3, 2007
Date

Signature of Second Inventor:


Young-Hoon KWON

September 3, 2007
Date

Signature of Third Inventor:


Sang-Boh YUN

September 3, 2007
Date